

01-28-2008

RECORDATION FORM COVER



Docket No.: 069576-0319

PATENTS ONLY

103477790

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Sergiy SHYLO, Mi Jeong YUN

Additional name(s) of conveying party(ies) attached?  Yes  No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): October 24, 2007

- Assignment  Merger
- Security Agreement  Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other

2. Name and address of receiving party(ies)

Name: SAMSUNG ELECTRO-MECHANICS CO., LTD.

Internal Address:

Address: 314 Maetan3-dong, Yeongtong-gu, Suwon, Gyeonggi-do, Republic of KOREA

Additional name(s) & address(es) attached?  Yes  No

4. Application or patent number(s):

A. Patent Application No(s).

This document is being filed together with a new application

B. Patent No(s).

Additional numbers attached?  Yes  No

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

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9. Signature.

Stephen A. Becker, 26,527

January 16, 2008

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: 2

01/25/2008 08:21:00 DBYRNE 00000084 500417 12007836  
01 FC:8021 40.00 DA

(SAB)  
Docket No.: \_\_\_\_\_

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- |                          |           |
|--------------------------|-----------|
| (1) <u>SHYLO, Sergiy</u> | (5) _____ |
| (2) <u>YUN, Mi Jeong</u> | (6) _____ |
| (3) _____                | (7) _____ |
| (4) _____                | (8) _____ |

who have made a certain new and useful invention, hereby sell, assign and transfer unto  
SAMSUNG ELECTRO-MECHANICS CO., LTD.  
314 Maetan3-dong, Yeongtong-gu, Suwon, Gyunggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States America as defined in 35 U.S.C. 100 in the invention entitled  
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(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_ and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed \_\_\_\_\_ and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue an and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissue substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successor assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to all improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated beside our signatures:

INVENTORS	DATE SIGNED
1) <u>Sergiy Shylo</u> Name: SHYLO, Sergiy	<u>2007. 10. 24</u>
2) <u>Yun, Mijeong</u> Name: YUN, Mi Jeong	<u>2007. 10. 24</u>
3) _____ Name: _____	_____
4) _____ Name: _____	_____
5) _____ Name: _____	_____